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Applications of "<u>Embedded - Microcontrollers</u>"

Details	
Product Status	Active
Core Processor	R8C
Core Size	16-Bit
Speed	20MHz
Connectivity	I <sup>2</sup> C, LINbus, SIO, SSU, UART/USART
Peripherals	POR, PWM, Voltage Detect, WDT
Number of I/O	15
Program Memory Size	4KB (4K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	A/D 4x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	20-LSSOP (0.173", 4.40mm Width)
Supplier Device Package	20-LSSOP
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f21321ddsp-w4

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R8C/32D Group 1. Overview

## 1.1.2 Specifications

Tables 1.1 and 1.2 outline the Specifications for R8C/32D Group.

Table 1.1 Specifications for R8C/32D Group (1)

Item	Function	Specification
CPU	Central processing	R8C CPU core
	unit	Number of fundamental instructions: 89
	uiiit	Minimum instruction execution time:
		50 ns (f(XIN) = 20 MHz, VCC = 2.7 to 5.5 V)
		200 ns (f(XIN) = 5 MHz, VCC = 1.8 to 5.5 V)  • Multiplier: 16 bits × 16 bits → 32 bits
		<ul> <li>• Multiply-accumulate instruction: 16 bits × 16 bits + 32 bits → 32 bits</li> </ul>
Momory	ROM, RAM	Operation mode: Single-chip mode (address space: 1 Mbyte)     Refer to Table 1.3 Product List for R8C/32D Group.
Memory Power Supply	Voltage detection	Power-on reset
	circuit	
Voltage Detection	Circuit	Voltage detection 3 (detection level of voltage detection 0 and voltage detection 1 selectable)
I/O Ports	Programmable I/O	,
I/O POILS		Input-only: 1 pin     CMOS I/O postor 15, polostoble pull up register.
	ports	CMOS I/O ports: 15, selectable pull-up resistor     Uligh gurrent drive ports: 15
Clock	Clock goneration	High current drive ports: 15     A circuits: VIN clock assillation circuit
Clock	Clock generation	4 circuits: XIN clock oscillation circuit,
	circuits	XCIN clock oscillation circuit (32 kHz) High-speed on-chip oscillator (with frequency adjustment function),
		Low-speed on-chip oscillator,
		Oscillation stop detection: XIN clock oscillation stop detection function     Transpared divides aircraft Dividing selectable 1, 0, 4, 8, and 10.
		• Frequency divider circuit: Dividing selectable 1, 2, 4, 8, and 16
		Low power consumption modes:     Other dead and add to be a seed of the land and a land to be a land to
		Standard operating mode (high-speed clock, low-speed clock, high-speed
		on-chip oscillator, low-speed on-chip oscillator), wait mode, stop mode
1		Real-time clock (timer RE)
Interrupts		• Number of interrupt vectors: 69
		• External Interrupt: 7 (INT × 3, Key input × 4)
\\/-+-		Priority levels: 7 levels
Watchdog Time	er	• 14 bits × 1 (with prescaler)
		Reset start selectable
	T D4	Low-speed on-chip oscillator for watchdog timer selectable
Timer	Timer RA	8 bits × 1 (with 8-bit prescaler) Timer mode (period timer), pulse output mode (output level inverted every
		period), event counter mode, pulse width measurement mode, pulse period
		measurement mode
	Timer RB	8 bits × 1 (with 8-bit prescaler)
	LIIIIGI UD	Timer mode (period timer), programmable waveform generation mode (PWM
		output), programmable one-shot generation mode, programmable wait one-
		shot generation mode
	Timer RC	16 bits × 1 (with 4 capture/compare registers)
		Timer mode (input capture function, output compare function), PWM mode
		(output 3 pins), PWM2 mode (PWM output pin)
	Timer RE	8 bits × 1
		Real-time clock mode (count seconds, minutes, hours, days of week)
Serial	UART0	Clock synchronous serial I/O/UART
Interface	UART2	Clock synchronous serial I/O/UART, I <sup>2</sup> C mode (I <sup>2</sup> C-bus),
		multiprocessor communication function
A/D Converter		10-bit resolution × 4 channels, includes sample and hold function, with sweep
		mode 2 circuits
Comparator B		

# 2. Central Processing Unit (CPU)

Figure 2.1 shows the CPU Registers. The CPU contains 13 registers. R0, R1, R2, R3, A0, A1, and FB configure a register bank. There are two sets of register bank.

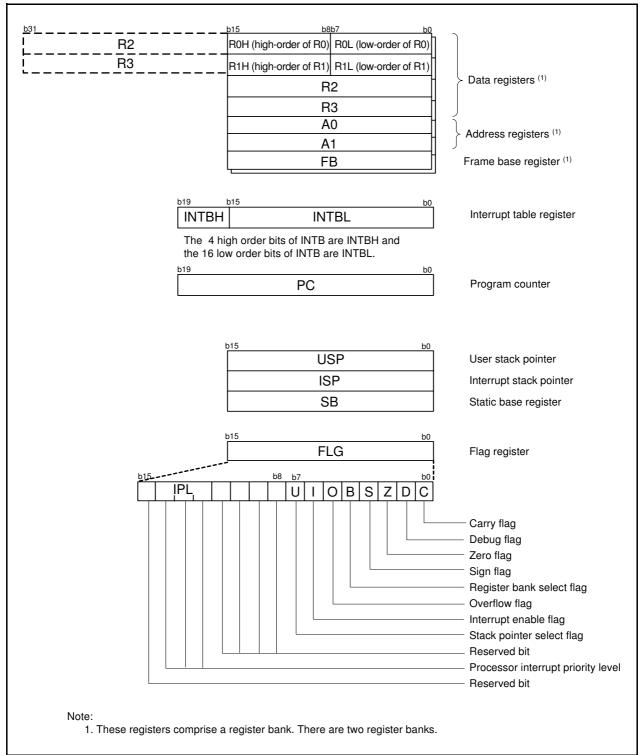


Figure 2.1 CPU Registers

### 2.1 Data Registers (R0, R1, R2, and R3)

R0 is a 16-bit register for transfer, arithmetic, and logic operations. The same applies to R1 to R3. R0 can be split into high-order bits (R0H) and low-order bits (R0L) to be used separately as 8-bit data registers. R1H and R1L are analogous to R0H and R0L. R2 can be combined with R0 and used as a 32-bit data register (R2R0). R3R1 is analogous to R2R0.

### 2.2 Address Registers (A0 and A1)

A0 is a 16-bit register for address register indirect addressing and address register relative addressing. It is also used for transfer, arithmetic, and logic operations. A1 is analogous to A0. A1 can be combined with A0 and as a 32-bit address register (A1A0).

### 2.3 Frame Base Register (FB)

FB is a 16-bit register for FB relative addressing.

### 2.4 Interrupt Table Register (INTB)

INTB is a 20-bit register that indicates the starting address of an interrupt vector table.

### 2.5 Program Counter (PC)

PC is 20 bits wide and indicates the address of the next instruction to be executed.

### 2.6 User Stack Pointer (USP) and Interrupt Stack Pointer (ISP)

The stack pointers (SP), USP and ISP, are each 16 bits wide. The U flag of FLG is used to switch between USP and ISP.

### 2.7 Static Base Register (SB)

SB is a 16-bit register for SB relative addressing.

### 2.8 Flag Register (FLG)

FLG is an 11-bit register indicating the CPU state.

### **2.8.1** Carry Flag (C)

The C flag retains carry, borrow, or shift-out bits that have been generated by the arithmetic and logic unit.

### 2.8.2 Debug Flag (D)

The D flag is for debugging only. Set it to 0.

### 2.8.3 **Zero Flag (Z)**

The Z flag is set to 1 when an arithmetic operation results in 0; otherwise to 0.

### 2.8.4 **Sign Flag (S)**

The S flag is set to 1 when an arithmetic operation results in a negative value; otherwise to 0.

### 2.8.5 Register Bank Select Flag (B)

Register bank 0 is selected when the B flag is 0. Register bank 1 is selected when this flag is set to 1.

### 2.8.6 Overflow Flag (O)

The O flag is set to 1 when an operation results in an overflow; otherwise to 0.

#### 2.8.7 Interrupt Enable Flag (I)

The I flag enables maskable interrupts.

Interrupts are disabled when the I flag is set to 0, and are enabled when the I flag is set to 1. The I flag is set to 0 when an interrupt request is acknowledged.

#### 2.8.8 Stack Pointer Select Flag (U)

ISP is selected when the U flag is set to 0; USP is selected when the U flag is set to 1.

The U flag is set to 0 when a hardware interrupt request is acknowledged or the INT instruction of software interrupt numbers 0 to 31 is executed.

#### 2.8.9 **Processor Interrupt Priority Level (IPL)**

IPL is 3 bits wide and assigns processor interrupt priority levels from level 0 to level 7. If a requested interrupt has higher priority than IPL, the interrupt is enabled.

#### 2.8.10 **Reserved Bit**

If necessary, set to 0. When read, the content is undefined.

#### **Special Function Registers (SFRs)** 4.

An SFR (special function register) is a control register for a peripheral function. Tables 4.1 to 4.8 list the special function registers and Table 4.9 lists the ID Code Areas and Option Function Select Area.

Table 4.1 SFR Information (1) (1)

	. ,		
Address	Register	Symbol	After Reset
0000h			
0001h			
0002h			
0003h			
0004h	Processor Mode Register 0	PM0	00h
0005h	Processor Mode Register 1	PM1	00h
0005h		CMO	
	System Clock Control Register 0		00101000b
0007h	System Clock Control Register 1	CM1	00100000b
0008h	Module Standby Control Register	MSTCR	00h
0009h	System Clock Control Register 3	CM3	00h
000Ah	Protect Register	PRCR	00h
000Bh	Reset Source Determination Register	RSTFR	0XXXXXXXb (2)
000Ch	Oscillation Stop Detection Register	OCD	00000100b
000Dh	Watchdog Timer Reset Register	WDTR	XXh
000Eh	Watchdog Timer Start Register	WDTS	XXh
	Waterland Times Control Deviates	WDTC	
000Fh	Watchdog Timer Control Register	WDIC	00111111b
0010h			
0011h			
0012h			
0013h			
0014h			
0015h	High-Speed On-Chip Oscillator Control Register 7	FRA7	When shipping
0016h		. 100	To Gpping
001011 0017h			+
001711 0018h			
0019h			
001Ah			
001Bh			
001Ch	Count Source Protection Mode Register	CSPR	00h
			10000000b (3)
001Dh			
001Eh			
001Fh			
0020h			
0020h			
0021h			
		LED AO	001
0023h	High-Speed On-Chip Oscillator Control Register 0	FRA0	00h
0024h	High-Speed On-Chip Oscillator Control Register 1	FRA1	When shipping
0025h	High-Speed On-Chip Oscillator Control Register 2	FRA2	00h
0026h	On-Chip Reference Voltage Control Register	OCVREFCR	00h
0027h			
0028h	Clock Prescaler Reset Flag	CPSRF	00h
	Clock Prescaler Reset Flag High-Speed On-Chip Oscillator Control Register 4	CPSRF FRA4	* *
0029h	High-Speed On-Chip Oscillator Control Register 4	FRA4	When Shipping
0029h 002Ah	High-Speed On-Chip Oscillator Control Register 4 High-Speed On-Chip Oscillator Control Register 5	FRA4 FRA5	When Shipping When Shipping
0029h 002Ah 002Bh	High-Speed On-Chip Oscillator Control Register 4	FRA4	When Shipping
0029h 002Ah 002Bh 002Ch	High-Speed On-Chip Oscillator Control Register 4 High-Speed On-Chip Oscillator Control Register 5	FRA4 FRA5	When Shipping When Shipping
0029h 002Ah 002Bh 002Ch 002Dh	High-Speed On-Chip Oscillator Control Register 4 High-Speed On-Chip Oscillator Control Register 5	FRA4 FRA5	When Shipping When Shipping
0029h 002Ah 002Bh 002Ch 002Dh 002Eh	High-Speed On-Chip Oscillator Control Register 4 High-Speed On-Chip Oscillator Control Register 5 High-Speed On-Chip Oscillator Control Register 6	FRA4 FRA5 FRA6	When Shipping When Shipping When Shipping
0029h 002Ah 002Bh 002Ch 002Dh 002Eh 002Fh	High-Speed On-Chip Oscillator Control Register 4 High-Speed On-Chip Oscillator Control Register 5 High-Speed On-Chip Oscillator Control Register 6  High-Speed On-Chip Oscillator Control Register 3	FRA4 FRA5 FRA6 FRA3	When Shipping When Shipping When Shipping When Shipping When shipping
0029h 002Ah 002Bh 002Ch 002Dh 002Eh 002Fh 0030h	High-Speed On-Chip Oscillator Control Register 4 High-Speed On-Chip Oscillator Control Register 5 High-Speed On-Chip Oscillator Control Register 6  High-Speed On-Chip Oscillator Control Register 3 Voltage Monitor Circuit Control Register	FRA4 FRA5 FRA6 FRA3 CMPA	When Shipping When Shipping When Shipping When Shipping  When shipping  Ooh
0029h 002Ah 002Bh 002Ch 002Dh 002Eh 002Fh	High-Speed On-Chip Oscillator Control Register 4 High-Speed On-Chip Oscillator Control Register 5 High-Speed On-Chip Oscillator Control Register 6  High-Speed On-Chip Oscillator Control Register 3 Voltage Monitor Circuit Control Register	FRA4 FRA5 FRA6 FRA3	When Shipping When Shipping When Shipping When Shipping When shipping
0029h 002Ah 002Bh 002Ch 002Dh 002Eh 002Fh 0030h	High-Speed On-Chip Oscillator Control Register 4 High-Speed On-Chip Oscillator Control Register 5 High-Speed On-Chip Oscillator Control Register 6  High-Speed On-Chip Oscillator Control Register 3	FRA4 FRA5 FRA6 FRA3 CMPA	When Shipping When Shipping When Shipping When Shipping  When shipping  Ooh
0029h 002Ah 002Bh 002Ch 002Dh 002Eh 002Fh 0030h 0031h	High-Speed On-Chip Oscillator Control Register 4 High-Speed On-Chip Oscillator Control Register 5 High-Speed On-Chip Oscillator Control Register 6  High-Speed On-Chip Oscillator Control Register 3 Voltage Monitor Circuit Control Register Voltage Monitor Circuit Edge Select Register	FRA4 FRA5 FRA6 FRA3 CMPA	When Shipping When Shipping When Shipping When Shipping  When shipping  Ooh
0029h 002Ah 002Bh 002Ch 002Dh 002Eh 002Fh 0030h 0031h 0032h	High-Speed On-Chip Oscillator Control Register 4 High-Speed On-Chip Oscillator Control Register 5 High-Speed On-Chip Oscillator Control Register 6  High-Speed On-Chip Oscillator Control Register 3  Voltage Monitor Circuit Control Register  Voltage Monitor Circuit Edge Select Register	FRA4 FRA5 FRA6 FRA3 CMPA VCAC	When Shipping When Shipping When Shipping When Shipping  When shipping  O0h  00h  00001000b
0029h 002Ah 002Bh 002Ch 002Dh 002Eh 002Fh 0030h 0031h	High-Speed On-Chip Oscillator Control Register 4 High-Speed On-Chip Oscillator Control Register 5 High-Speed On-Chip Oscillator Control Register 6  High-Speed On-Chip Oscillator Control Register 3 Voltage Monitor Circuit Control Register Voltage Monitor Circuit Edge Select Register	FRA4 FRA5 FRA6 FRA3 CMPA VCAC	When Shipping When Shipping When Shipping When Shipping  When shipping  Oth  000  0001000b  0001400b
0029h 002Ah 002Bh 002Ch 002Ch 002Eh 003Ch 0031h 0031h 0032h 0033h	High-Speed On-Chip Oscillator Control Register 4 High-Speed On-Chip Oscillator Control Register 5 High-Speed On-Chip Oscillator Control Register 6  High-Speed On-Chip Oscillator Control Register 3  Voltage Monitor Circuit Control Register  Voltage Monitor Circuit Edge Select Register	FRA4 FRA5 FRA6 FRA3 CMPA VCAC	When Shipping When Shipping When Shipping When Shipping  When shipping  O0h  00h  00001000b
0029h 002Ah 002Bh 002Ch 002Dh 002Eh 002Fh 0030h 0031h 0032h 0033h 0034h	High-Speed On-Chip Oscillator Control Register 4 High-Speed On-Chip Oscillator Control Register 5 High-Speed On-Chip Oscillator Control Register 6  High-Speed On-Chip Oscillator Control Register 3 Voltage Monitor Circuit Control Register Voltage Monitor Circuit Edge Select Register  Voltage Detect Register 1 Voltage Detect Register 2	FRA4 FRA5 FRA6  FRA3 CMPA VCAC  VCA1 VCA2	When Shipping When Shipping When Shipping When Shipping  When shipping  Oth Oth Oth Oth Oth Oth Oth Oth Oth Ot
0029h 002Ah 002Bh 002Ch 002Dh 002Eh 002Fh 0030h 0031h 0032h 0033h 0034h	High-Speed On-Chip Oscillator Control Register 4 High-Speed On-Chip Oscillator Control Register 5 High-Speed On-Chip Oscillator Control Register 6  High-Speed On-Chip Oscillator Control Register 3  Voltage Monitor Circuit Control Register  Voltage Monitor Circuit Edge Select Register	FRA4 FRA5 FRA6 FRA3 CMPA VCAC	When Shipping When Shipping When Shipping When Shipping  When shipping  Oth  000  0001000b  0001400b
0029h 002Ah 002Bh 002Ch 002Dh 002Eh 002Fh 0030h 0031h 0032h 0033h 0034h 0036h 0037h	High-Speed On-Chip Oscillator Control Register 4 High-Speed On-Chip Oscillator Control Register 5 High-Speed On-Chip Oscillator Control Register 6  High-Speed On-Chip Oscillator Control Register 3 Voltage Monitor Circuit Control Register Voltage Monitor Circuit Edge Select Register  Voltage Detect Register 1 Voltage Detect Register 2  Voltage Detection 1 Level Select Register	FRA4 FRA5 FRA6  FRA3 CMPA VCAC  VCA1 VCA2	When Shipping When Shipping When Shipping When Shipping  When shipping  Oth Oth Oth Oth Oth Oth Oth Oth Oth Ot
0029h 002Ah 002Bh 002Ch 002Dh 002Eh 002Fh 0030h 0031h 0032h 0033h 0034h	High-Speed On-Chip Oscillator Control Register 4 High-Speed On-Chip Oscillator Control Register 5 High-Speed On-Chip Oscillator Control Register 6  High-Speed On-Chip Oscillator Control Register 3 Voltage Monitor Circuit Control Register Voltage Monitor Circuit Edge Select Register  Voltage Detect Register 1 Voltage Detect Register 2	FRA4 FRA5 FRA6  FRA3 CMPA VCAC  VCA1 VCA2	When Shipping When Shipping When Shipping When Shipping  When shipping  Oth Oth Oth Oth Oth Oth Oth Oth Oth Ot
0029h 002Ah 002Bh 002Ch 002Dh 002Eh 002Fh 0030h 0031h 0032h 0033h 0034h 0036h 0037h	High-Speed On-Chip Oscillator Control Register 4 High-Speed On-Chip Oscillator Control Register 5 High-Speed On-Chip Oscillator Control Register 6  High-Speed On-Chip Oscillator Control Register 3 Voltage Monitor Circuit Control Register Voltage Monitor Circuit Edge Select Register  Voltage Detect Register 1 Voltage Detect Register 2  Voltage Detection 1 Level Select Register	FRA4 FRA5 FRA6  FRA3 CMPA VCAC  VCA1 VCA2	When Shipping When Shipping When Shipping When Shipping  When shipping  00h  00h  00h  0001000b  00h (4)  00100000b (5)

# X: Undefined Notes:

- The blank areas are reserved and cannot be accessed by users.

  The CWR bit in the RSTFR register is set to 0 after power-on and voltage monitor 0 reset. Hardware reset, software reset, or watchdog timer reset does not affect this bit.
- The CSPROINI bit in the OFS register is set to 0. 3.
- The LVDAS bit in the OFS register is set to 1.
- The LVDAS bit in the OFS register is set to 0.

SFR Information (4) (1) Table 4.4

Address	Register	Symbol	After Reset
	A/D Register 0	AD0	XXh
00C1h			000000XXb
00C2h	A/D Register 1	AD1	XXh
00C3h	ŭ		000000XXb
00C4h	A/D Register 2	AD2	XXh
00C5h			000000XXb
00C6h	A/D Register 3	AD3	XXh
00C7h			000000XXb
00C8h	A/D Register 4	AD4	XXh
00C9h			000000XXb
00CAh	A/D Register 5	AD5	XXh
00CBh	<del></del>	1.23	000000XXb
	A/D Register 6	AD6	XXh
00CDh			000000XXb
	A/D Register 7	AD7	XXh
00CFh			000000XXb
00D0h			
00D1h			
00D2h			
00D3h			
	A/D Mode Register	ADMOD	00h
	A/D Input Select Register	ADINSEL	11000000b
00D6h	A/D Control Register 0	ADCON0	00h
00D0h	A/D Control Register 1	ADCON1	00h
00D7H	A/D Control register 1	ADOONT	0011
00D0h			
00D3h			+
00DAII			
00DBh			
00DDh			
00DBh			
00DEn			
00E0h			
	Port P1 Register	P1	XXh
00E111	roit FT negister	F1	^^!!
	Port P1 Direction Register	PD1	00h
00E3H	FOIL FT DIRECTION REGISTER	FDI	0011
	Port P3 Register	P3	XXh
00E6h	FOIL F3 Register	13	AAII
00E8H	Port P3 Direction Register	PD3	00h
00E7II	Port P4 Register	P4	XXh
00E9h	FOIL F4 Register		AAII
	Port P4 Direction Register	PD4	00h
00EAn	FOILE 4 DIRECTION DEGISTER	PD4	00h
00EGh			
00EDh			
00EDn 00EEh			
00EFh			
00EFn 00F0h			
00F0h 00F1h			
00F2h			
00F3h			
00F4h			
00F5h			
00F6h			
00F7h			
00F8h			
00F9h			
00FAh			
00FBh			
00FCh			
00FDh			
00FEh			
00FFh			1

X: Undefined

Note:

1. The blank areas are reserved and cannot be accessed by users.

SFR Information (5) (1) Table 4.5

01001	Register	Symbol	After Reset
0100h	Timer RA Control Register	TRACR	00h
0101h	Timer RA I/O Control Register	TRAIOC	00h
0102h	Timer RA Mode Register	TRAMR	00h
0103h	Timer RA Prescaler Register	TRAPRE	FFh
0104h	Timer RA Register	TRA	FFh
0105h			
0106h			
0100h			
	T	TDD00	
0108h	Timer RB Control Register	TRBCR	00h
0109h	Timer RB One-Shot Control Register	TRBOCR	00h
010Ah	Timer RB I/O Control Register	TRBIOC	00h
010Bh	Timer RB Mode Register	TRBMR	00h
010Ch	Timer RB Prescaler Register	TRBPRE	FFh
010Dh	Timer RB Secondary Register	TRBSC	FFh
010Eh	Timer RB Primary Register	TRBPR	FFh
	Timer no Filmary negister	INDEN	1111
010Fh			
0110h			
0111h			
0112h			
0113h			
0114h			<del></del>
0115h			+
0116h			
0117h			
0118h	Timer RE Second Data Register	TRESEC	00h
0119h	Timer RE Minute Data Register	TREMIN	00h
011Ah	Timer RE Hour Data Register	TREHR	00h
011Bh	Timer RE Day of Week Data Register	TREWK	00h
011Ch	Timer RE Control Register 1	TRECR1	00h
011Dh	Timer RE Control Register 2	TRECR2	00h
	Timer RE Count Source Select Register		
011Eh	Timer RE Count Source Select Register	TRECSR	00001000b
011Fh			
0120h	Timer RC Mode Register	TRCMR	01001000b
0121h	Timer RC Control Register 1	TRCCR1	00h
0122h	Timer RC Interrupt Enable Register	TRCIER	01110000b
0123h	Timer RC Status Register	TRCSR	01110000b
0124h	Timer RC I/O Control Register 0	TRCIOR0	10001000b
0125h	Timer RC I/O Control Register 1	TRCIOR1	10001000b
0126h	Timer RC Counter	TRC	00h
0127h			00h
0128h	Timer RC General Register A	TRCGRA	FFh
0129h			FFh
012Ah	Timer RC General Register B	TRCGRB	FFh
012Bh	d v		FFh
012Ch	Timer RC General Register C	TRCGRC	FFh
0120h	- Innortio deneral register o	THOGHO	FFh
	Time at DO Comment Desciretos D	TROOPS	
012Eh	Timer RC General Register D	TRCGRD	FFh
012Fh			FFh
0130h	Timer RC Control Register 2	TRCCR2	00011000b
0131h	Timer RC Digital Filter Function Select Register	TRCDF	00h
0132h	Timer RC Output Master Enable Register	TRCOER	01111111b
0133h	Timer RC Trigger Control Register	TRCADCR	00h
0134h			
0135h			
0136h			
0137h			
0138h			
0139h			
013Ah			
013Bh			<del></del>
013Ch			
013Dh			
0405			
013Eh 013Fh			

Note:

1. The blank areas are reserved and cannot be accessed by users.

SFR Information (7) (1) Table 4.7

Address	Register	Symbol	After Reset
0180h	Timer RA Pin Select Register	TRASR	00h
0181h	Timer RC Pin Select Register	TRBRCSR	00h
0182h	Timer RC Pin Select Register 0	TRCPSR0	00h
0183h	Timer RC Pin Select Register 1	TRCPSR1	00h
0184h			
0185h			
0186h			
0187h			
0188h	UART0 Pin Select Register	U0SR	00h
0189h	Office of the gister	50611	0011
018Ah	LIAPTO Din Coloat Pagiatar 0	U2SR0	00h
	UART2 Pin Select Register 0 UART2 Pin Select Register 1		
018Bh	UARTZ PIN Select Register 1	U2SR1	00h
018Ch			
018Dh			
018Eh	INT Interrupt Input Pin Select Register	INTSR	00h
018Fh	I/O Function Pin Select Register	PINSR	00h
0190h			
0191h			
0192h			
0193h			
0194h		1	<del> </del>
0194H		<del> </del>	<del> </del>
0193H			
0196h			ļ
0197h			1
0198h			
0199h			
019Ah			
019Bh			
019Ch			
019Dh			
019Eh			
019Fh			
01A0h			-
014011			
01A1h			
01A2h			
01A3h			
01A4h			
01A5h			
01A6h			
01A7h			
01A8h			
01A9h			
01AAh			
		-	
01ABh		-	
01ACh			1
01ADh			
01AEh			
01AFh			
01B0h			
01B1h			
01B2h	Flash Memory Status Register	FST	10000X00b
01B3h	,	<u> </u>	
01B4h	Flash Memory Control Register 0	FMR0	00h
01B4II	Flash Memory Control Register 1	FMR1	00h
01B6h	Flash Memory Control Register 2	FMR2	00h
01B7h			
01B8h			
01B9h			
01BAh			
01BBh			
01BCh			
01BDh		<del> </del>	+
		-	
01BEh			ļ
01BFh			

X: Undefined
Note:
1. The blank areas are reserved and cannot be accessed by users.

# 5. Electrical Characteristics

Table 5.1 Absolute Maximum Ratings

Symbol	Parameter	Condition	Rated Value	Unit
Vcc/AVcc	Supply voltage		-0.3 to 6.5	V
Vı	Input voltage		-0.3 to Vcc + 0.3	V
Vo	Output voltage		-0.3 to Vcc + 0.3	V
Pd	Power dissipation	$-40^{\circ}\text{C} \le \text{Topr} \le 85^{\circ}\text{C}$	500	mW
Topr	Operating ambient temperature		-20 to 85 (N version) /	°C
			-40 to 85 (D version)	
Tstg	Storage temperature		-65 to 150	°C

Table 5.2 **Recommended Operating Conditions** 

Symbol		Dor	ameter		Conditions		Standard		Unit
Symbol		ran	ametel		Conditions	Min.	Тур.	Max.	
Vcc/AVcc	Supply voltage					1.8	-	5.5	V
Vss/AVss	Supply voltage					-	0	_	V
VIH	Input "H" voltage	Other than	n CMOS inp	ut		0.8 Vcc	-	Vcc	V
		CMOS		Input level selection	4.0 V ≤ Vcc ≤ 5.5 V	0.5 Vcc	-	Vcc	V
		input	switching	: 0.35 Vcc	2.7 V ≤ Vcc < 4.0 V	0.55 Vcc	_	Vcc	V
			function		1.8 V ≤ Vcc < 2.7 V	0.65 Vcc	_	Vcc	V
			(I/O port)	Input level selection	4.0 V ≤ Vcc ≤ 5.5 V	0.65 Vcc	_	Vcc	V
				: 0.5 Vcc	2.7 V ≤ Vcc < 4.0 V	0.7 Vcc	_	Vcc	V
					1.8 V ≤ Vcc < 2.7 V	0.8 Vcc	-	Vcc	V
				Input level selection	4.0 V ≤ Vcc ≤ 5.5 V	0.85 Vcc	-	Vcc	V
	AVSS Supply voltage Input "H" voltage  Input "L" voltage  Input "L" voltage  Input "L" voltage  Average sum output Isum) Average sum output Isum) Peak output "H" coltage  Average output "H" coltage  Average sum output Isum) Peak sum output Isum) Average sum output Isum) Peak output "L" coltage  Average output			: 0.7 Vcc	2.7 V ≤ Vcc < 4.0 V	0.85 Vcc	-	Vcc	V
					1.8 V ≤ Vcc < 2.7 V	0.85 Vcc	_	Vcc	V
		External c	lock input (X	OUT)		1.2	_	Vcc	V
VIL	Input "L" voltage	Other than	n CMOS inp	ut		0	_	0.2 Vcc	V
		CMOS		Input level selection	4.0 V ≤ Vcc ≤ 5.5 V	0	-	0.2 Vcc	V
	input	switching	: 0.35 Vcc	2.7 V ≤ Vcc < 4.0 V	0	_	0.2 Vcc	V	
		function		1.8 V ≤ Vcc < 2.7 V	0	_	0.2 Vcc	V	
			(I/O port)	Input level selection	4.0 V ≤ Vcc ≤ 5.5 V	0	_	0.4 Vcc	V
				: 0.5 Vcc	2.7 V ≤ Vcc < 4.0 V	0	_	0.3 Vcc	V
					1.8 V ≤ Vcc < 2.7 V	0	-	0.2 Vcc	V
				Input level selection	4.0 V ≤ Vcc ≤ 5.5 V	0	_	0.55 Vcc	V
				: 0.7 Vcc	2.7 V ≤ Vcc < 4.0 V	0	_	0.45 Vcc	V
					1.8 V ≤ Vcc < 2.7 V	0	-	0.35 Vcc	V
		External c	lock input (X	OUT)		0	_	0.4	V
IOH(sum)	Peak sum output "	H" current	Sum of all	pins IOH(peak)		-	-	-160	mA
IOH(sum)	Average sum output	"H" current	Sum of all	pins IOH(avg)		_	_	-80	mA
IOH(peak)	Peak output "H" co	urrent	Drive capa	city Low		_	_	-10	mA
			Drive capa	city High		=	-	-40	mA
IOH(avg)	Average output "H	l" current	Drive capa	city Low		=	-	-5	mA
			Drive capa	city High		=	-	-20	mA
IOL(sum)	Peak sum output '	L" current	Sum of all	pins IOL(peak)		=	-	160	mA
IOL(sum)	Average sum output	"L" current	Sum of all	pins IOL(avg)		=	-	80	mA
IOL(peak)	Peak output "L" cu	ırrent	Drive capa	city Low		=	-	10	mA
			Drive capa	city High		=	=	40	mA
IOL(avg)	Average output "L	" current	Drive capa	city Low		-	-	5	mA
			Drive capa	city High		-	-	20	mA
f(XIN)	XIN clock input os	cillation free	quency		2.7 V ≤ Vcc ≤ 5.5 V	-	-	20	MHz
					1.8 V ≤ Vcc < 2.7 V	-	-	5	MHz
f(XCIN)	XCIN clock input of	scillation fr	equency		1.8 V ≤ Vcc ≤ 5.5 V	=	32.768	50	kHz
fOCO40M	When used as the o	count source	for timer RC	(3)	2.7 V ≤ Vcc ≤ 5.5 V	32	=	40	MHz
fOCO-F	fOCO-F frequency	/			2.7 V ≤ Vcc ≤ 5.5 V	-	_	20	MHz
					1.8 V ≤ Vcc < 2.7 V	-	-	5	MHz
_	System clock freq	uency			2.7 V ≤ Vcc ≤ 5.5 V	_	_	20	MHz
					1.8 V ≤ Vcc < 2.7 V	_	_	5	MHz
f(BCLK)	CPU clock freque	ncy			2.7 V ≤ Vcc ≤ 5.5 V	_	_	20	MHz
	·				1.8 V ≤ Vcc < 2.7 V	_	_	5	MHz

### Notes:

- 1. Vcc = 1.8 to 5.5 V at Topr = -20 to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.
- The average output current indicates the average value of current measured during 100 ms.
   fOCO40M can be used as the count source for timer RC in the range of Vcc = 2.7 V to 5.5V.

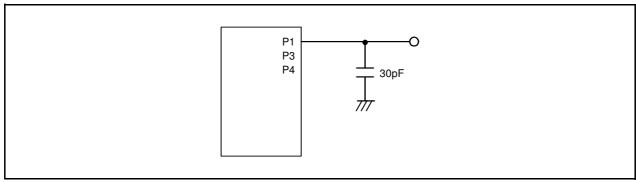


Figure 5.1 Ports P1, P3, P4 Timing Measurement Circuit

**Voltage Detection 0 Circuit Electrical Characteristics** Table 5.6

Cumbal	Parameter	Condition		Standard	l	Unit
Symbol	raiameter	Condition	Min.	Тур.	Max.	Unit
Vdet0	Voltage detection level Vdet0_0 (2)		1.80	1.90	2.05	V
	Voltage detection level Vdet0_1 (2)		2.15	2.35	2.50	V
	Voltage detection level Vdet0_2 (2)		2.70	2.85	3.05	V
	Voltage detection level Vdet0_3 (2)		3.55	3.80	4.05	V
_	Voltage detection 0 circuit response time (4)	At the falling of Vcc from 5 V to (Vdet0_0 - 0.1) V	-	6	150	μS
=	Voltage detection circuit self power consumption	VCA25 = 1, Vcc = 5.0 V	-	1.5	-	μА
td(E-A)	Waiting time until voltage detection circuit operation starts (3)		-	-	100	μS

#### Notes:

- 1. The measurement condition is Vcc = 1.8 V to 5.5 V and  $T_{opr} = -20$  to  $85^{\circ}C$  (N version) / -40 to  $85^{\circ}C$  (D version).
- Select the voltage detection level with bits VDSEL0 and VDSEL1 in the OFS register.
- Necessary time until the voltage detection circuit operates when setting to 1 again after setting the VCA25 bit in the VCA2 register to 0.
- 4. Time until the voltage monitor 0 reset is generated after the voltage passes Vdeto.

Table 5.7 **Voltage Detection 1 Circuit Electrical Characteristics** 

Symbol	Parameter	Condition		Standard	l	Unit
Symbol	Parameter	Condition	Min.	Тур.	Max.	Offic
Vdet1	Voltage detection level Vdet1_0 (2)	At the falling of Vcc	2.00	2.20	2.40	V
	Voltage detection level Vdet1_1 (2)	At the falling of Vcc	2.15	2.35	2.55	V
	Voltage detection level Vdet1_2 (2)	At the falling of Vcc	2.30	2.50	2.70	V
	Voltage detection level Vdet1_3 (2)	At the falling of Vcc	2.45	2.65	2.85	V
	Voltage detection level Vdet1_4 (2)	At the falling of Vcc	2.60	2.80	3.00	V
	Voltage detection level Vdet1_5 (2)	At the falling of Vcc	2.75	2.95	3.15	V
	Voltage detection level Vdet1_6 (2)	At the falling of Vcc	2.85	3.10	3.40	V
	Voltage detection level Vdet1_7 (2)	At the falling of Vcc	3.00	3.25	3.55	V
	Voltage detection level Vdet1_8 (2)	At the falling of Vcc	3.15	3.40	3.70	V
	Voltage detection level Vdet1_9 (2)	At the falling of Vcc	3.30	3.55	3.85	V
	Voltage detection level Vdet1_A (2)	At the falling of Vcc	3.45	3.70	4.00	V
	Voltage detection level Vdet1_B (2)	At the falling of Vcc	3.60	3.85	4.15	V
	Voltage detection level Vdet1_C (2)	At the falling of Vcc	3.75	4.00	4.30	V
	Voltage detection level Vdet1_D (2)	At the falling of Vcc	3.90	4.15	4.45	V
	Voltage detection level Vdet1_E (2)	At the falling of Vcc	4.05	4.30	4.60	V
	Voltage detection level Vdet1_F (2)	At the falling of Vcc	4.20	4.45	4.75	V
=	Hysteresis width at the rising of Vcc in voltage detection 1 circuit	Vdet1_0 to Vdet1_5 selected	_	0.07	_	V
		Vdet1_6 to Vdet1_F selected	_	0.10	-	V
=	Voltage detection 1 circuit response time (3)	At the falling of Vcc from 5 V to (Vdet1_0 – 0.1) V	_	60	150	μS
_	Voltage detection circuit self power consumption	VCA26 = 1, Vcc = 5.0 V	_	1.7	_	μΑ
td(E-A)	Waiting time until voltage detection circuit operation starts (4)		=	=	100	μS

### Notes:

- 1. The measurement condition is Vcc = 1.8 V to 5.5 V and Topr = -20 to  $85^{\circ}C$  (N version) / -40 to  $85^{\circ}C$  (D version).
- 2. Select the voltage detection level with bits VD1S0 to VD1S3 in the VD1LS register.
- 3. Time until the voltage monitor 1 interrupt request is generated after the voltage passes Vdet1.
- 4. Necessary time until the voltage detection circuit operates when setting to 1 again after setting the VCA26 bit in the VCA2 register to 0.

Table 5.13 Electrical Characteristics (1) [4.2 V  $\leq$  Vcc  $\leq$  5.5 V]

Symbol		Parameter	Condition		S	Standard		Unit
Syllibol	'	rarameter	Condition	Min.	Тур.	Max.	Offit	
Vон	Output "H"	Other than XOUT	Drive capacity High Vcc = 5 V	lон = −20 mA	Vcc - 2.0	=	Vcc	V
	voltage		Drive capacity Low Vcc = 5 V	Iон = −5 mA	Vcc - 2.0	=	Vcc	V
		XOUT	Vcc = 5V	IOH = -200 μA	1.0	=	Vcc	V
Vol	Output "L"	Other than XOUT	Drive capacity High Vcc = 5 V	IoL = 20 mA	-	=	2.0	V
	voltage		Drive capacity Low Vcc = 5 V	IoL = 5 mA	-	=	2.0	V
		XOUT	Vcc = 5V	IOL = 200 μA	=	=	0.5	V
VT+-VT-	Hysteresis	INTO, INT1, INT3, KIO, KI1, KI2, KI3, TRAIO, TRBO, TRCIOA, TRCIOB, TRCIOC, TRCTRG, TRCTRG, RXD0, RXD2, CLK0, CLK2			0.1	1.2	-	>
		RESET			0.1	1.2	_	V
Iн	Input "H" cu		VI = 5 V, VCC = 5.0 V		-	_	5.0	μΑ
İι	Input "L" cu	rrent	VI = 0 V, $VCC = 5.0 V$		=	-	-5.0	μΑ
RPULLUP	Pull-up resis	stance	VI = 0 V, $VCC = 5.0 V$		25	50	100	kΩ
RfXIN	Feedback resistance	XIN			-	0.3	-	ΜΩ
Rfxcin	Feedback resistance	XCIN			_	8	_	ΜΩ
VRAM	RAM hold v	oltage	During stop mode		1.8	-	-	V

### Note:

<sup>1. 4.2</sup> V ≤ Vcc ≤ 5.5 V at Topr = −20 to 85°C (N version) / −40 to 85°C (D version), f(XIN) = 20 MHz, unless otherwise specified.

Table 5.14 Electrical Characteristics (2) [3.3 V  $\leq$  Vcc  $\leq$  5.5 V] (Topr = -20 to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.)

Symbol	Parameter	Condition			Standard	t	Unit
Syllibol	Farameter		Condition	Min.	Тур.	Max.	UIIII
CC	Power supply current (Vcc = 3.3 to 5.5 V)	High-speed clock mode	XIN = 20 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	_	6.5	15	mA
	Single-chip mode, output pins are open, other pins		XIN = 16 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	_	5.3	12.5	mA
	are Vss		XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	_	3.6	-	mA
			XIN = 20 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	_	3.0	_	mA
			XIN = 16 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	_	2.2	_	mA
			XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	_	1.5	_	mA
		High-speed on-chip oscillator mode	XIN clock off High-speed on-chip oscillator on fOCO-F = 20 MHz Low-speed on-chip oscillator on = 125 kHz No division	_	7.0	15	mA
			XIN clock off High-speed on-chip oscillator on fOCO-F = 20 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-8	_	3.0	_	mA
			XIN clock off High-speed on-chip oscillator on fOCO-F = 4 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-16 MSTTRC = 1	-	1	_	mA
		Low-speed on-chip oscillator mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8, FMR27 = 1, VCA20 = 0	_	90	400	μА
		Low-speed clock mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz No division FMR27 = 1, VCA20 = 0	-	85	400	μА
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz No division Program operation on RAM Flash memory off, FMSTP = 1, VCA20 = 0	-	47	-	μА
		Wait mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock operation VCA27 = VCA26 = VCA25 = 0 VCA20 = 1	-	15	100	μА
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock off VCA27 = VCA26 = VCA25 = 0 VCA20 = 1	_	4	90	μΑ
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz (peripheral clock off) While a WAIT instruction is executed VCA27 = VCA26 = VCA25 = 0 VCA20 = 1	-	3.5	-	μА
		Stop mode	XIN clock off, Topr = 25°C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA27 = VCA26 = VCA25 = 0	_	2.0	5.0	μΑ
			XIN clock off, Topr = 85°C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off	-	5.0	_	μА

### **Timing Requirements**

(Unless Otherwise Specified: Vcc = 5 V, Vss = 0 V at Topr = 25°C)

Table 5.15 External Clock Input (XOUT, XCIN)

Symbol	Parameter	Standard		Unit
	Falametel	Min.	Max.	Offic
tc(XOUT)	XOUT input cycle time	50	-	ns
twh(xout)	XOUT input "H" width	24	=	ns
twl(xout)	XOUT input "L" width	24	=	ns
tc(XCIN)	XCIN input cycle time	14	=	μS
twh(xcin)	XCIN input "H" width	7	=	μS
twl(xcin)	XCIN input "L" width	7	-	μS

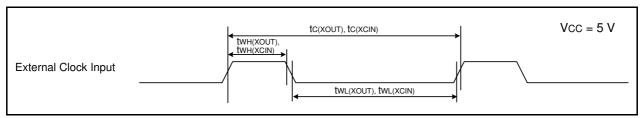


Figure 5.4 External Clock Input Timing Diagram when Vcc = 5 V

Table 5.16 TRAIO Input

Symbol	Parameter	Standard		Unit
		Min.	Max.	Ullit
tc(TRAIO)	TRAIO input cycle time	100	=	ns
twh(traio)	TRAIO input "H" width	40	-	ns
twl(traio)	TRAIO input "L" width	40	=	ns

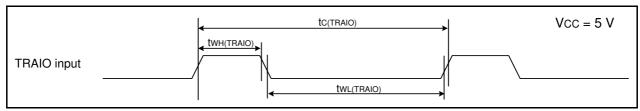


Figure 5.5 TRAIO Input Timing Diagram when Vcc = 5 V

Table 5.19 Electrical Characteristics (3) [2.7 V  $\leq$  Vcc < 4.2 V]

Symbol	Parar	motor	Condition		Condition		Standard		Unit
Syllibol	raiai	netei	Condition	JII	Min.	n. Typ. Max.		Offic	
Vон	Output "H" voltage	Other than XOUT	Drive capacity High	IOH = −5 mA	Vcc - 0.5	=	Vcc	V	
			Drive capacity Low	IOH = -1 mA	Vcc - 0.5	=	Vcc	V	
		XOUT		$IOH = -200 \mu A$	1.0	=	Vcc	V	
Vol	Output "L" voltage	Other than XOUT	Drive capacity High	IOL = 5 mA	-	-	0.5	V	
			Drive capacity Low	IOL = 1 mA	=	=	0.5	V	
		XOUT		IOL = 200 μA	=	=	0.5	V	
VT+-VT-	Hysteresis	INTO, INT1, INT3, KIO, KI1, KI2, KI3, TRAIO, TRBO, TRCIOA, TRCIOB, TRCIOC, TRCIOC, TRCIOC, TRCTRG, TRCCLK, ADTRG, RXD0, RXD2, CLK0, CLK2	Vcc = 3.0 V		0.1	0.4	_	V	
lін	Input "H" current		VI = 3 V, Vcc = 3.0 \	/	=	=	4.0	μА	
lıL	Input "L" current		VI = 0 V, VCC = 3.0 \	/	-	_	-4.0	μА	
RPULLUP	Pull-up resistance		VI = 0 V, Vcc = 3.0 \	/	42	84	168	kΩ	
RfXIN	Feedback resistance	XIN			=	0.3	-	MΩ	
RfXCIN	Feedback resistance	XCIN			I	8	-	МΩ	
VRAM	RAM hold voltage		During stop mode		1.8	-	_	V	

### Note:

<sup>1.</sup>  $2.7 \text{ V} \le \text{Vcc} < 4.2 \text{ V}$  at  $\text{Topr} = -20 \text{ to } 85^{\circ}\text{C}$  (N version) /  $-40 \text{ to } 85^{\circ}\text{C}$  (D version), f(XIN) = 10 MHz, unless otherwise specified.

Electrical Characteristics (4) [2.7 V  $\leq$  Vcc < 3.3 V] **Table 5.20** (Topr = -20 to  $85^{\circ}$ C (N version) / -40 to  $85^{\circ}$ C (D version), unless otherwise specified.)

Symbol	Parameter	Parameter Condition	Standard			Unit	
Symbol	Farameter		Condition	Min.	Тур.	Max.	Unit
lcc	Power supply current (Vcc = 2.7 to 3.3 V) Single-chip mode,	High-speed clock mode	XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	-	3.5	10	mA
output pins are ope other pins are Vss	output pins are open, other pins are Vss		XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	_	1.5	7.5	mA
		High-speed on-chip oscillator mode	XIN clock off High-speed on-chip oscillator on fOCO-F = 20 MHz Low-speed on-chip oscillator on = 125 kHz No division	-	7.0	15	mA
			XIN clock off High-speed on-chip oscillator on fOCO-F = 20 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-8	-	3.0	=	mA
			XIN clock off High-speed on-chip oscillator on fOCO-F = 10 MHz Low-speed on-chip oscillator on = 125 kHz No division	-	4.0	=	mA
			XIN clock off High-speed on-chip oscillator on fOCO-F = 10 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-8	-	1.5	=	mA
			XIN clock off High-speed on-chip oscillator on fOCO-F = 4 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-16 MSTTRC = 1	=	1	=	mA
		Low-speed on-chip oscillator mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8, FMR27 = 1, VCA20 = 0	-	90	390	μА
		Low-speed clock mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz No division FMR27 = 1, VCA20 = 0	-	80	400	μА
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz No division Program operation on RAM Flash memory off, FMSTP = 1, VCA20 = 0	-	40	_	μА
		Wait mode	XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock operation VCA27 = VCA26 = VCA25 = 0, VCA20 = 1	-	15	90	μА
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock off VCA27 = VCA26 = VCA25 = 0, VCA20 = 1	-	4	80	μА
			XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz (peripheral clock off) While a WAIT instruction is executed VCA27 = VCA26 = VCA25 = 0, VCA20 = 1	-	3.5	=	μА
		Stop mode	XIN clock off, Topr = 25°C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA27 = VCA26 = VCA25 = 0	-	2.0	5.0	μА
			XIN clock off, Topr = 85°C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off	_	5.0	_	μА

### **Timing requirements**

(Unless Otherwise Specified: Vcc = 3 V, Vss = 0 V at Topr = 25°C)

Table 5.21 External Clock Input (XOUT, XCIN)

Symbol	Parameter	Standard	dard	Unit
	Parameter	Min.	Max.	Unit
tc(XOUT)	XOUT input cycle time	50	-	ns
twh(xout)	XOUT input "H" width	24	-	ns
twl(xout)	XOUT input "L" width	24	-	ns
tc(XCIN)	XCIN input cycle time	14	-	μ\$
twh(xcin)	XCIN input "H" width	7	-	μ\$
tWL(XCIN)	XCIN input "L" width	7	-	μS

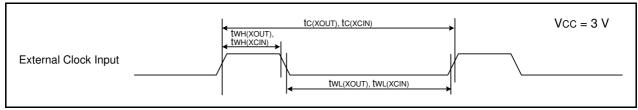


Figure 5.8 External Clock Input Timing Diagram when Vcc = 3 V

Table 5.22 TRAIO Input

Symbol	Parameter	Standard		Unit
	raidilletei	Min.	Max.	Offic
tc(TRAIO)	TRAIO input cycle time	300	-	ns
twh(traio)	TRAIO input "H" width	120	-	ns
twl(traio)	TRAIO input "L" width	120	-	ns

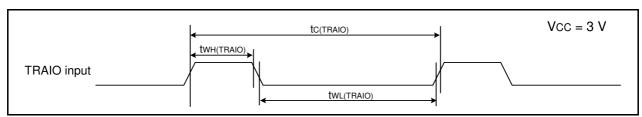


Figure 5.9 TRAIO Input Timing Diagram when Vcc = 3 V

### **Timing requirements**

(Unless Otherwise Specified: Vcc = 2.2 V, Vss = 0 V at Topr = 25°C)

Table 5.27 External Clock Input (XOUT, XCIN)

Symbol	Parameter	Standard		Unit
	Farameter	Min.	Max.	Ullit
tc(XOUT)	XOUT input cycle time	200	-	ns
twh(xout)	XOUT input "H" width	90	-	ns
twl(xout)	XOUT input "L" width	90	-	ns
tc(XCIN)	XCIN input cycle time	14	-	μS
twh(xcin)	XCIN input "H" width	7	=	μS
tWL(XCIN)	XCIN input "L" width	7	_	μS

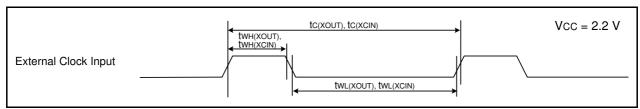


Figure 5.12 External Clock Input Timing Diagram when Vcc = 2.2 V

Table 5.28 TRAIO Input

Symbol	Parameter	Standard		Unit
		Min.	Max.	Offic
tc(TRAIO)	TRAIO input cycle time	500	-	ns
twh(traio)	TRAIO input "H" width	200	=	ns
twl(traio)	TRAIO input "L" width	200	-	ns



Figure 5.13 TRAIO Input Timing Diagram when Vcc = 2.2 V